2 A Three-quadrant triacs high commutation

Rev. 01 — 7 February 2008

**Product data sheet** 

### 1. Product profile

#### 1.1 General description

Passivated high commutation triacs in a SOT186A 'full pack' plastic package. These triacs balance the requirements of commutation performance and gate sensitivity. The 'sensitive' gate E series and 'logic level' D series are intended for interfacing with low-power drivers, including microcontrollers.

#### 1.2 Features

- Sensitive gate
- Very high commutation performance maximized at each gate sensitivity

### **1.3 Applications**

Motor control

#### 1.4 Quick reference data

- V<sub>DRM</sub> ≤ 600 V (BTA202X-600D)
- V<sub>DRM</sub> ≤ 600 V (BTA202X-600E)
- V<sub>DRM</sub> ≤ 800 V (BTA202X-800D)
- V<sub>DRM</sub>  $\leq$  800 V (BTA202X-800E)
- $I_{T(RMS)} \le 2 A$

- High immunity to dV/dt
  High isolation voltage
- Solenoid driver
- I<sub>GT</sub>  $\leq$  5 mA (BTA202X-600D)
- I<sub>GT</sub> ≤ 10 mA (BTA202X-600E)
- $I_{GT} \leq 5 \text{ mA (BTA202X-800D)}$
- I<sub>GT</sub> ≤ 10 mA (BTA202X-800E)





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## 2. Pinning information

Table 1.	Pinning		
Pin	Description	Simplified outline	Graphic symbol
1	main terminal 1 (T1)		N 1
2	main terminal 2 (T2)	mb	T2-T1
3	gate (G)		sym051
mb	mounting base (isolated)		

SOT186A (TO-220F)

## 3. Ordering information

Table 2. Ordering information						
Type number	Package					
	Name	Description	Version			
BTA202X-600D	TO-220F	plastic single-ended package; isolated heatsink mounted; 1 mounting hole;	SOT186A			
BTA202X-600E		3-lead TO-220 'full pack'				
BTA202X-800D						
BTA202X-800E						

## 4. Limiting values

#### Table 3.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DRM</sub>	repetitive peak off-state voltage	BTA202X-600D; BTA202X-600E	<u>[1]</u> _	600	V
		BTA202X-800D; BTA202X-800E		800	V
I <sub>T(RMS)</sub>	RMS on-state current	full sine wave; T <sub>h</sub> ≤ 110 °C; see <u>Figure 4</u> and <u>5</u>	-	2	A
I <sub>TSM</sub>	non-repetitive peak on-state current	full sine wave; $T_j = 25 \text{ °C prior to}$ surge; see Figure 2 and 3			
		t = 20 ms	-	14	А
		t = 16.7 ms	-	15.4	А
l <sup>2</sup> t	I <sup>2</sup> t for fusing	t <sub>p</sub> = 10 ms	-	0.98	A <sup>2</sup> s
dl <sub>T</sub> /dt	rate of rise of on-state current	$\begin{split} I_{TM} &= 1.5 \text{ A}; \text{ I}_{G} = 0.2 \text{ A}; \\ dI_{G}/dt &= 0.2 \text{ A}/\mu\text{s} \end{split}$	-	100	A/μs
I <sub>GM</sub>	peak gate current		-	2	А
P <sub>GM</sub>	peak gate power		-	5	W

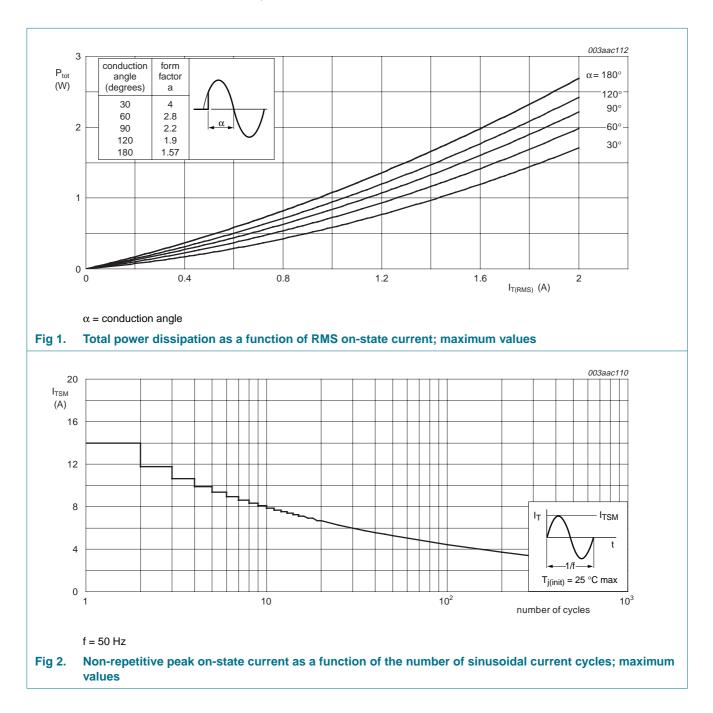
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#### Table 3. Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
P <sub>G(AV)</sub>	average gate power	over any 20 ms period	-	0.5	W
T <sub>stg</sub>	storage temperature		-40	+150	°C
Tj	junction temperature		-	125	°C

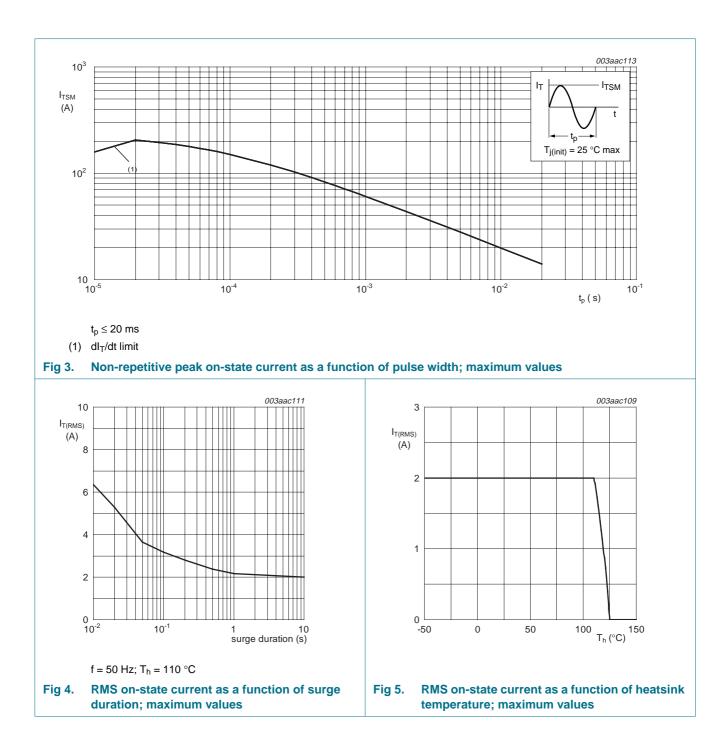
[1] Although not recommended, off-state voltages up to 800 V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 6 A/μs.



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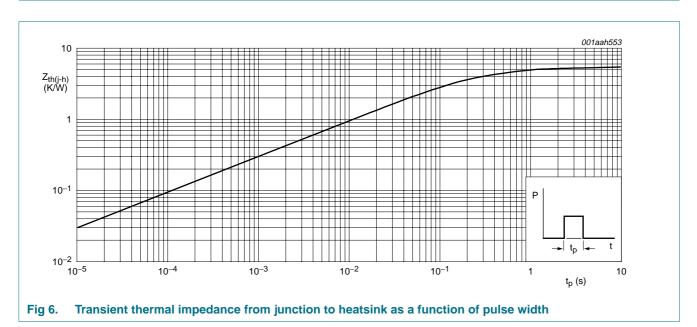
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### 5. Thermal characteristics

Table 4.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-h)</sub>	thermal resistance from junction to heatsink	bidirectional; see Figure 6	-	-	5.5	K/W
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	-	55	-	K/W



### 6. Isolation characteristics

#### Table 5. Isolation limiting values and characteristics

 $T_h = 25 \circ C$  unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
V <sub>isol(RMS)</sub>	RMS isolation voltage	from all three terminals to external heatsink; f = 50 Hz to 60 Hz; sinusoidal waveform; RH $\leq$ 65 %; clean and dust free	-	-	2500	V
C <sub>isol</sub>	isolation capacitance	from pin 2 to external heatsink; f = 1 MHz	-	10	-	pF

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## 7. Static characteristics

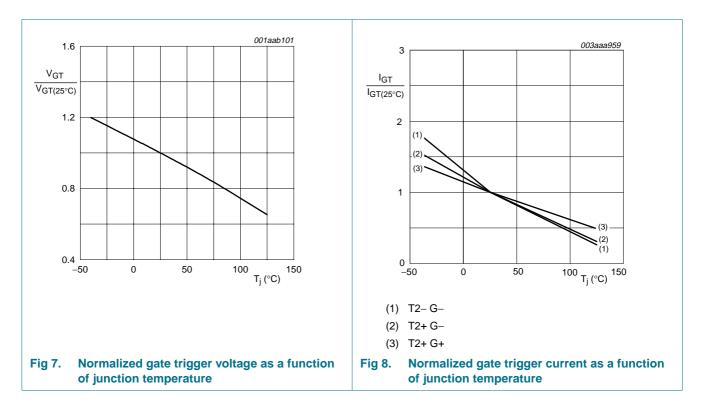
 $T_i = 25 \circ C$  unless otherwise specified.

Symbol	Parameter	Conditions		BTA202X-600D BTA202X-800D			BTA202X-600E BTA202X-800E		
			Min	Тур	Max	Min	Тур	Max	
I <sub>GT</sub>	gate trigger current	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A};$ see <u>Figure 8</u>	·						
		T2+ G+	0.25	-	5	0.5	-	10	mA
		T2+ G–	0.25	-	5	0.5	-	10	mA
		T2– G–	0.25	-	5	0.5	-	10	mA
IL latching current	V <sub>D</sub> = 12 V; I <sub>GT</sub> = 0.1 A; see <u>Figure 10</u>								
		T2+ G+	-	-	5	-	-	12	mA
		T2+ G-	-	-	10	-	-	20	mA
		T2- G-	-	-	5	-	-	12	mA
Ι <sub>Η</sub>	holding current	V <sub>D</sub> = 12 V; I <sub>GT</sub> = 0.1 A; see <u>Figure 11</u>	-	-	5	-	-	12	mA
VT	on-state voltage	I <sub>T</sub> = 3 A; see <u>Figure 9</u>	-	1.63	2	-	1.63	2	V
V <sub>GT</sub>	gate trigger voltage	$V_D = 12 \text{ V}; \text{ I}_T = 0.1 \text{ A};$ see Figure 7	-	0.7	1.5	-	0.7	1.5	V
		$V_D = 400 \text{ V}; I_T = 0.1 \text{ A};$ $T_j = 125 \text{ °C}$	0.2	0.3	-	0.2	0.3	-	V
I <sub>D</sub>	off-state current	V <sub>D</sub> = V <sub>DRM(max)</sub> ; T <sub>j</sub> = 125 °C	-	0.1	0.5	-	0.1	0.5	mA

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## 8. Dynamic characteristics

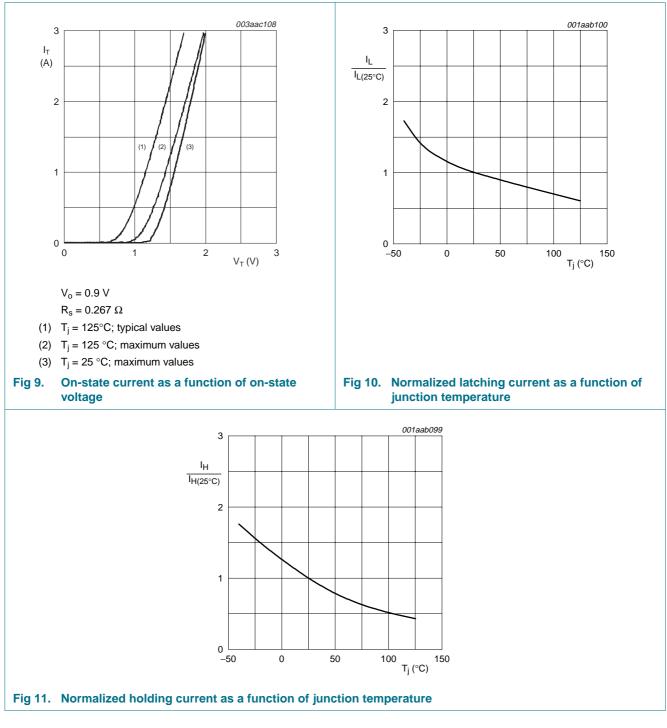
Table 7.	Dynamic chara	cteristics							
Symbol Parame	Parameter	Conditions	BTA202X-600D BTA202X-800D			BTA202X-600E BTA202X-800E			Unit
			Min	Тур	Max	Min	Тур	Max	1
dV <sub>D</sub> /dt	rate of rise of off-state voltage	$V_{DM} = 0.67 \times V_{DRM(max)}$ ; $T_j = 125 \ ^{\circ}C$ ; exponential waveform; $R_{(G-MT1)} = 220 \ \Omega$	-	350	-	-	500	-	V/μs
dl <sub>com</sub> /dt rate of change of commutating current	$V_{DM}$ = 400 V; T <sub>j</sub> = 125 °C; I <sub>T(RMS)</sub> = 2 A; dV <sub>com</sub> /dt = 20 V/µs; gate open circuit	1.0	-	-	2.0	-	-	A/ms	
	$V_{DM} = 400 \text{ V}; \text{ T}_{j} = 125 \text{ °C}; \text{ I}_{T(RMS)} = 2 \text{ A};$ $dV_{com}/dt = 10 \text{ V}/\mu s;$ gate open circuit	1.2	-	-	2.3	-	-	A/ms	
t <sub>gt</sub>	gate-controlled turn-on time	$\begin{split} I_{TM} &= 20 \text{ A};  V_D = V_{DRM(max)};  I_G = 0.1 \text{ A}; \\ dI_G/dt &= 5  A/\mu \text{s} \end{split}$	-	2	-	-	2	-	μs



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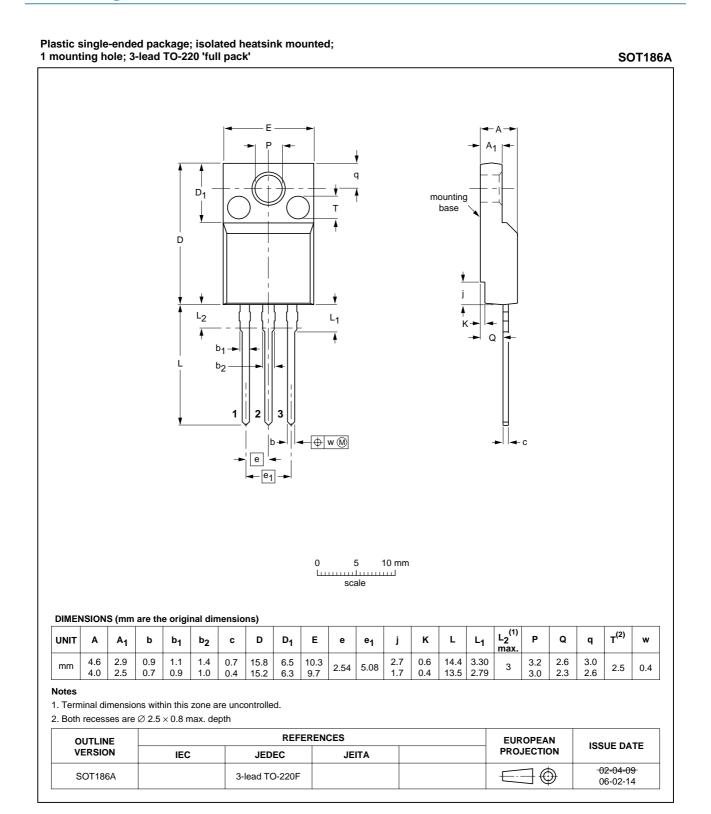
### 9. Package information

Refer to mounting instructions for F-pack packages.

Epoxy meets UL94 V-0 at 3.175 mm.

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### **10. Package outline**



#### Fig 12. Package outline SOT186A (3-lead TO-220F)

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## **11. Revision history**

Table 8. Revision hist	ory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
BTA202X_SER_D_E_1	20080207	Product data sheet	-	-

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### 12. Legal information

#### 12.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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